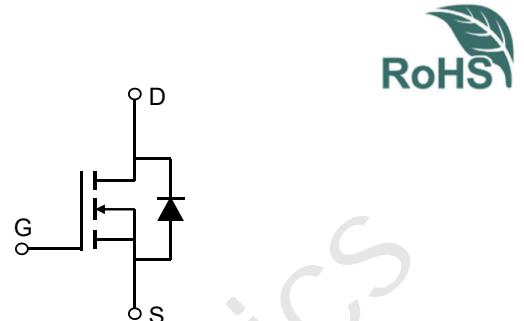


### Description

### Features

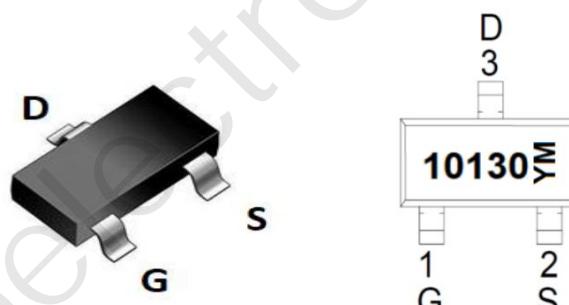
- 100V, 3.5A
- $R_{DS(ON)}$  Typ = 91mΩ @  $V_{GS}$  = 10V
- $R_{DS(ON)}$  Typ = 118mΩ @  $V_{GS}$  = 4.5V
- Advanced Split Gate Trench Technology
- Excellent  $R_{DS(ON)}$  and Low Gate Charge
- Lead Free



Schematic Diagram

### Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

### Package Marking and Ordering Information

| Device       | Marking | Package   | Outline | Reel Size | Reel (pcs) | Per Carton (pcs) |
|--------------|---------|-----------|---------|-----------|------------|------------------|
| CRMJGL10130A | 10130   | SOT-23-3L | TAPING  | 7"        | 3000       | 120000           |

### Absolute Maximum Ratings (@ $T_J$ = 25°C unless otherwise specified)

| Symbol          | Parameter                                              | Value      | Units |
|-----------------|--------------------------------------------------------|------------|-------|
| $V_{DS}$        | Drain-to-Source Voltage                                | 100        | V     |
| $V_{GS}$        | Gate-to-Source Voltage                                 | $\pm 20$   | V     |
| $I_D$           | Continuous Drain Current<br>$T_A = 25^\circ\text{C}$   | 3.5        | A     |
|                 | $T_A = 100^\circ\text{C}$                              | 2.1        | A     |
| $I_{DM}$        | Pulsed Drain Current <sup>(1)</sup>                    | 14         | A     |
| $P_D$           | Power Dissipation<br>$T_A = 25^\circ\text{C}$          | 3.1        | W     |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient <sup>(2)</sup> | 40.3       | °C/W  |
| $T_J, T_{STG}$  | Junction & Storage Temperature Range                   | -55 to 150 | °C    |

### Electrical Characteristics ( $T_J = 25^\circ\text{C}$ unless otherwise specified)

| Symbol                                                    | Parameter                                                | Conditions                                                 | Min. | Typ. | Max.      | Unit             |
|-----------------------------------------------------------|----------------------------------------------------------|------------------------------------------------------------|------|------|-----------|------------------|
| <b>Off Characteristics</b>                                |                                                          |                                                            |      |      |           |                  |
| $V_{(\text{BR})\text{DSS}}$                               | Drain-Source Breakdown Voltage                           | $I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$                 | 100  | -    | -         | V                |
| $I_{\text{DSS}}$                                          | Zero Gate Voltage Drain Current                          | $V_{DS} = 100\text{V}, V_{GS} = 0\text{V}$                 | -    | -    | 1.0       | $\mu\text{A}$    |
| $I_{\text{GSS}}$                                          | Gate-Body Leakage Current                                | $V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$              | -    | -    | $\pm 100$ | nA               |
| <b>On Characteristics</b>                                 |                                                          |                                                            |      |      |           |                  |
| $V_{GS(\text{th})}$                                       | Gate Threshold Voltage                                   | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$                    | 1    | 1.65 | 2.5       | V                |
| $R_{\text{DS(ON)}}$                                       | Static Drain-Source ON-Resistance <sup>(3)</sup>         | $V_{GS} = 10\text{V}, I_D = 3\text{A}$                     | -    | 91   | 118       | $\text{m}\Omega$ |
|                                                           |                                                          | $V_{GS} = 4.5\text{V}, I_D = 1\text{A}$                    | -    | 118  | 154       | $\text{m}\Omega$ |
| <b>Dynamic Characteristics</b>                            |                                                          |                                                            |      |      |           |                  |
| $C_{\text{iss}}$                                          | Input Capacitance                                        |                                                            | -    | 203  | -         | pF               |
| $C_{\text{oss}}$                                          | Output Capacitance                                       | $V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = 1\text{MHz}$ | -    | 83   | -         | pF               |
| $C_{\text{rss}}$                                          | Reverse Transfer Capacitance                             |                                                            | -    | 13   | -         | pF               |
| $Q_g$                                                     | Total Gate Charge                                        |                                                            | -    | 4    | -         | nC               |
| $Q_{gs}$                                                  | Gate Source Charge                                       | $V_{GS} = 0 \text{ to } 10\text{V}$                        | -    | 0.9  | -         | nC               |
| $Q_{gd}$                                                  | Gate Drain("Miller") Charge                              | $V_{DS} = 50\text{V}, I_D = 3\text{A}$                     | -    | 1.1  | -         | nC               |
| <b>Switching Characteristics</b>                          |                                                          |                                                            |      |      |           |                  |
| $t_{d(on)}$                                               | Turn-On DelayTime                                        |                                                            | -    | 13   | -         | ns               |
| $t_r$                                                     | Turn-On Rise Time                                        | $V_{GS} = 10\text{V}, V_{DD} = 50\text{V}$                 | -    | 19   | -         | ns               |
| $t_{d(off)}$                                              | Turn-Off DelayTime                                       | $I_D = 3\text{A}, R_{\text{GEN}} = 3\Omega$                | -    | 20   | -         | ns               |
| $t_f$                                                     | Turn-Off Fall Time                                       |                                                            | -    | 28   | -         | ns               |
| <b>Drain-Source Diode Characteristics and Max Ratings</b> |                                                          |                                                            |      |      |           |                  |
| $I_S$                                                     | Maximum Continuous Drain to Source Diode Forward Current |                                                            | -    | -    | 3.5       | A                |
| $I_{\text{SM}}$                                           | Maximum Pulsed Drain to Source Diode Forward Current     |                                                            | -    | -    | 14        | A                |
| $V_{SD}$                                                  | Drain to Source Diode Forward Voltage                    | $V_{GS} = 0\text{V}, I_S = 3\text{A}$                      | -    | -    | 1.2       | V                |
| $trr$                                                     | Body Diode Reverse Recovery Time                         |                                                            | -    | 30   | -         | ns               |
| $Qrr$                                                     | Body Diode Reverse Recovery Charge                       | $I_F = 3\text{A}, di/dt = 100\text{A}/\mu\text{s}$         | -    | 37   | -         | nC               |

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2.  $R_{\theta JA}$  is measured with the device mounted on a 1inch<sup>2</sup> pad of 2oz copper FR4 PCB

3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .

### Test Circuit

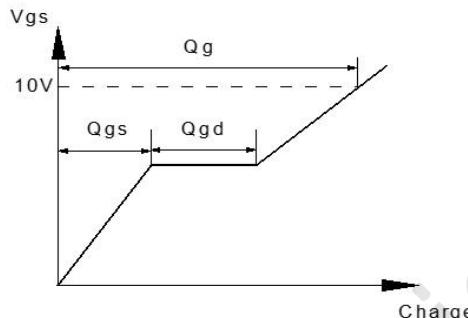
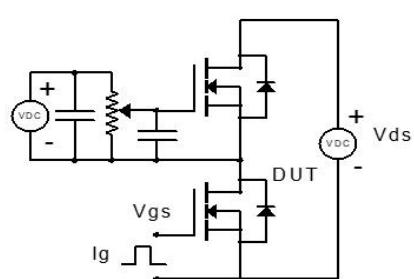


Figure 1: Gate Charge Test Circuit & Waveform

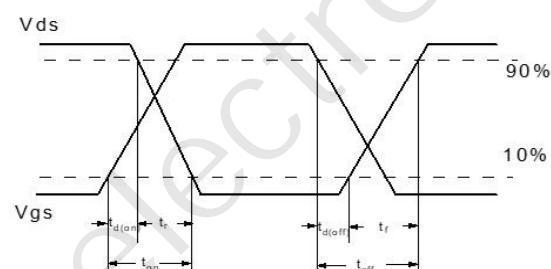
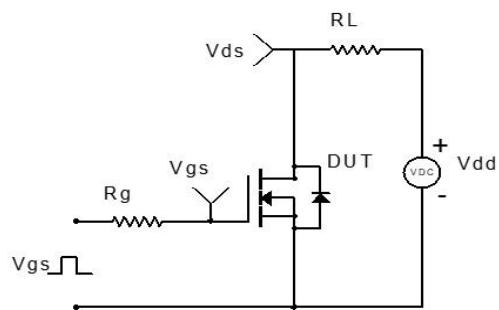


Figure 2: Resistive Switching Test Circuit & Waveform

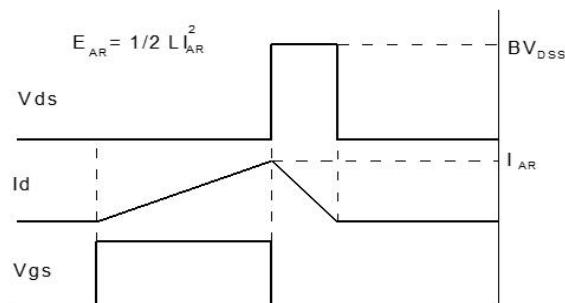
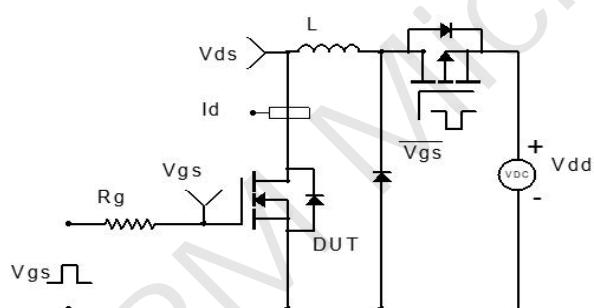


Figure 3: Unclamped Inductive Switching Test Circuit & Waveform

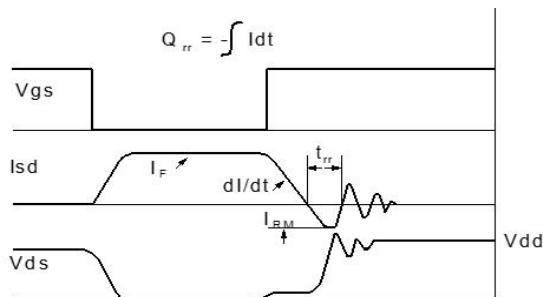
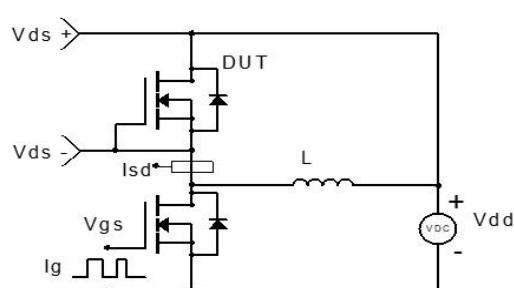
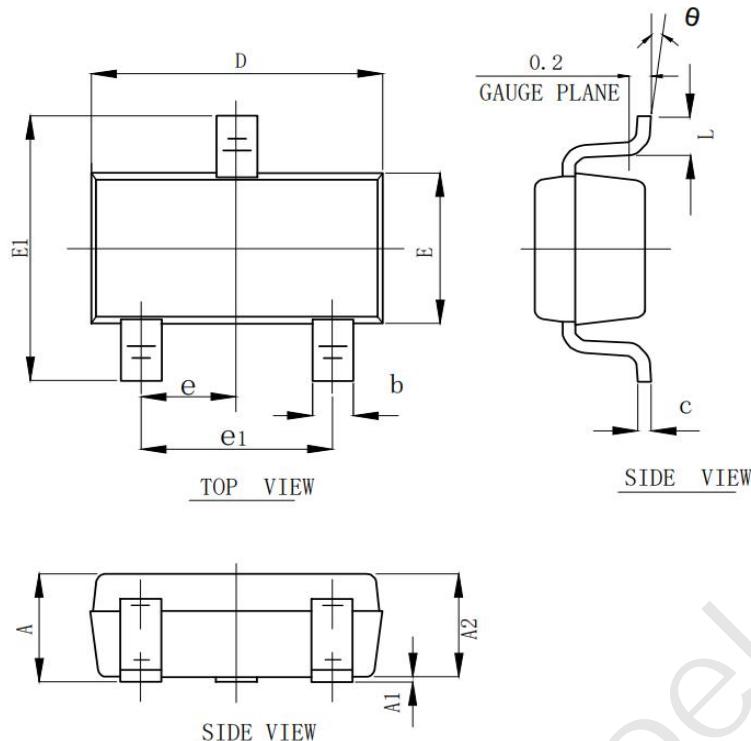


Figure 4: Diode Recovery Test Circuit & Waveform

## Package Mechanical Data(SOT-23-3L)



COMMON DIMENSIONS  
(UNITS OF MEASURE=mm)

| SYMBOL         | MIN  | NOM     | MAX  |
|----------------|------|---------|------|
| A              | —    | —       | 1.30 |
| A1             | 0.00 | 0.05    | 0.10 |
| A2             | 1.00 | 1.10    | 1.20 |
| b              | 0.30 | 0.40    | 0.50 |
| c              | 0.10 | 0.125   | 0.15 |
| e <sub>1</sub> | 1.80 | 1.90    | 2.00 |
| D              | 2.80 | 2.90    | 3.00 |
| E              | 1.50 | 1.60    | 1.70 |
| E1             | 2.60 | 2.80    | 3.00 |
| L              | 0.30 | 0.45    | 0.60 |
| θ              | 0°   | 4°      | 8°   |
| e              | —    | 0.95BSC | —    |

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